**Product data sheet** 

## 1. General description

Planar passivated SCR with sensitive gate in a SOT223 (SC-73) surface mountable plastic package. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

#### 2. Features and benefits

- Sensitive gate
- Planar passivated for voltage ruggedness and reliability
- Direct triggering from low power drivers and logic ICs
- Surface mountable package

## 3. Applications

- Adapters
- Battery powered applications
- Industrial automation

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage			-	-	600	V
$I_{T(AV)}$	average on-state current	half sine wave; $T_{sp} \le 112 ^{\circ}\text{C}$ ; Fig. 1		-	-	0.6	Α
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; $T_{sp} \le 112 ^{\circ}\text{C}$ ; Fig. 2; Fig. 3		-	-	1	A
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5		-	-	10	Α
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms		-	-	11	А
Tj	junction temperature		[1]	-	-	125	°C
Static charact	eristics						
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 9$		-	50	200	μA
Dynamic char	acteristics						
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; $T_j$ = 125 °C; $R_{GK}$ = 100 Ω; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 14		-	50	-	V/µs

[1] Operation above  $110^{\circ}$ C may require the use of a gate to cathode resistor of  $1k\Omega$  or less.

# 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	4	A <del>-                                   </del>
2	Α	anode		Ġ sym037
3	G	gate		symosi
4	mb	mb; connected to anode	⊟1 ⊟2 ⊟3 SC-73 (SOT223)	

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package					
	Name	Description	Version			
BT148W-600R	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223			

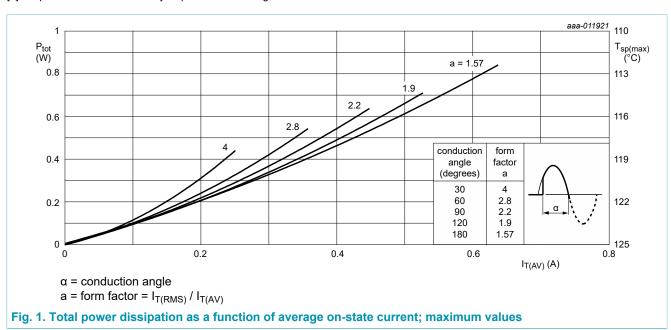
## 7. Limiting values

**Table 4. Limiting values** 

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		[1]	-	600	V
$V_{RRM}$	repetitive peak reverse voltage			-	600	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>sp</sub> ≤ 112 °C; <u>Fig. 1</u>		-	0.6	Α
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>sp</sub> ≤ 112 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>		-	1	Α
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5		-	10	А
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms		-	11	Α
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; SIN		-	0.5	A²s
dl <sub>T</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 400 μA		-	100	A/µs
I <sub>GM</sub>	peak gate current			-	1	Α
$V_{RGM}$	peak reverse gate voltage			-	5	V
P <sub>GM</sub>	peak gate power			-	1.2	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period		-	0.12	W
T <sub>stg</sub>	storage temperature			-40	150	°C
T <sub>j</sub>	junction temperature		[2]	-	125	°C

- [1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the thyristor may switch to the onstate.
- [2] Operation above 110°C may require the use of a gate to cathode resistor of  $1k\Omega$  or less.



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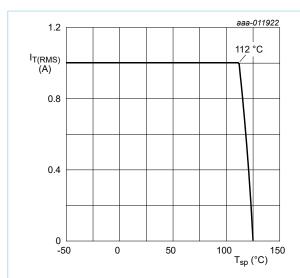


Fig. 2. RMS on-state current as a function of solder point temperature; maximum values

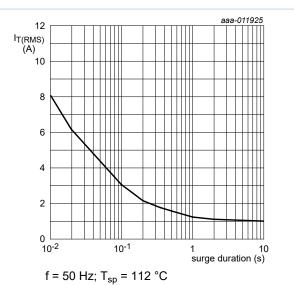


Fig. 3. RMS on-state current as a function of surge duration; maximum values

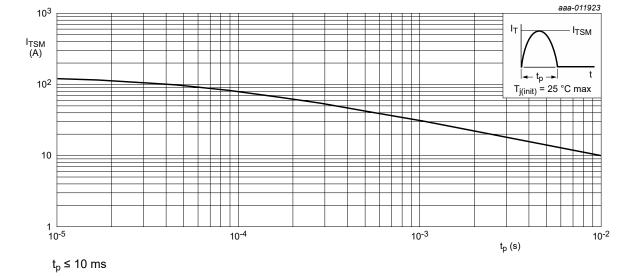


Fig. 4. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

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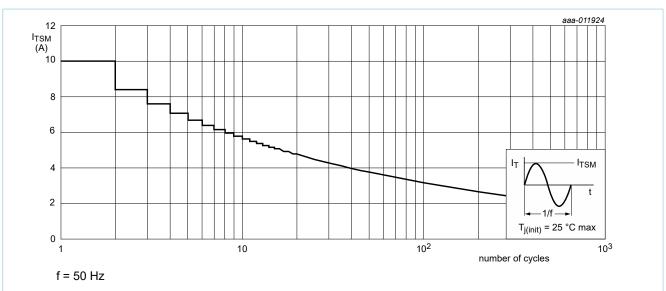
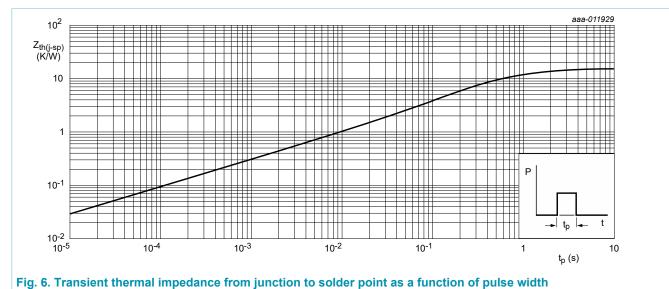


Fig. 5. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

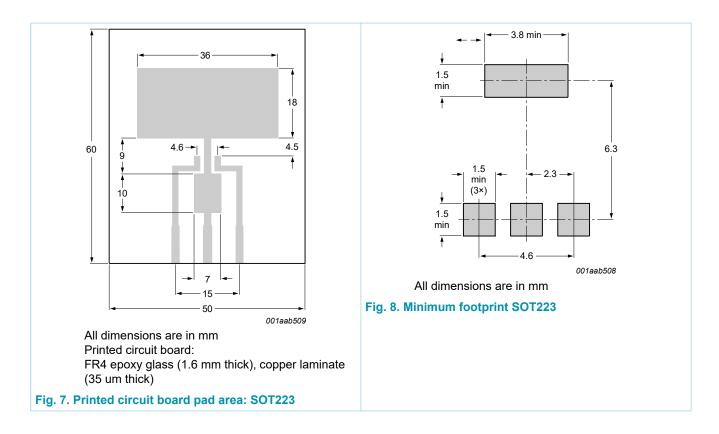
### 8. Thermal characteristics

**Table 5. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point	Fig. 6	-	-	15	K/W
$R_{th(j-a)}$	thermal resistance from junction to	printed circuit board mounted; pad area; Fig. 7	-	70	-	K/W
	ambient free air	printed circuit board mounted; minimum footprint; Fig. 8	-	156	-	K/W



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### 9. Characteristics

**Table 6. Characteristics** 

Symbol	Parameter	Conditions	Mi	n Typ	Max	Unit
Static chara	acteristics		1	<u> </u>		
I <sub>GT</sub>	gate trigger current	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	50	200	μΑ
IL	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25 \text{ °C};$ Fig. 10	-	0.17	10	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 11</u>	-	0.1	6	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 2 A; T <sub>j</sub> = 25 °C; <u>Fig. 12</u>	-	1.3	1.5	V
V <sub>GT</sub>	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$ Fig. 13	-	0.4	1	V
		$V_D = 600 \text{ V}; I_T = 0.1 \text{ A}; T_j = 125 \text{ °C};$ Fig. 13	0.	1 0.2	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 600 V; T <sub>j</sub> = 125 °C	-	0.1	0.5	mA
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 125 °C	-	0.1	0.5	mA
Dynamic ch	naracteristics					
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; $T_j$ = 125 °C; $R_{GK}$ = 100 Ω; $(V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 14	-	50	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM}$ = 4 A; $V_D$ = 600 V; $I_G$ = 5 mA; $dI_G/$ dt = 0.2 A/µs; $T_j$ = 25 °C	-	2	-	μs
t <sub>q</sub>	commutated turn-off time	$V_{DM}$ = 402 V; $T_j$ = 125 °C; $I_{TM}$ = 4 A; $V_R$ = 35 V; $(dI_T/dt)_M$ = 30 A/µs; $dV_D/dt$ = 2 V/µs; $R_{GK(ext)}$ = 1 k $\Omega$ ; $(V_{DM}$ = 67% of $V_{DRM})$	-	100	-	μs

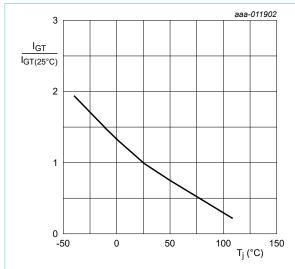


Fig. 9. Normalized gate trigger current as a function of junction temperature

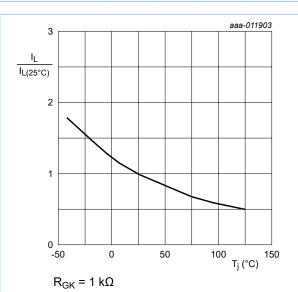


Fig. 10. Normalized latching current as a function of junction temperature

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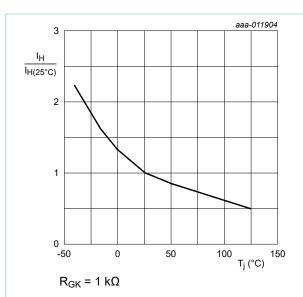


Fig. 11. Normalized holding current as a function of junction temperature

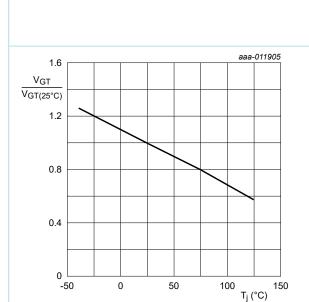
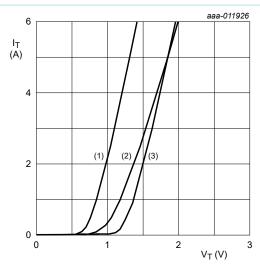


Fig. 13. Normalized gate trigger voltage as a function of junction temperature



 $V_o$  = 1.107 V;  $R_s$  = 0.14 Ω (1)  $T_j$  = 125 °C; typical values (2)  $T_j$  = 125 °C; maximum values (3)  $T_j$  = 25 °C; maximum values

Fig. 12. On-state current as a function of on-state voltage

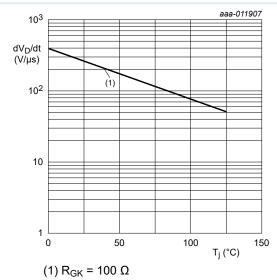


Fig. 14. Critical rate of rise of off-state voltage as a function of junction temperature; typical values

## 10. Package outline

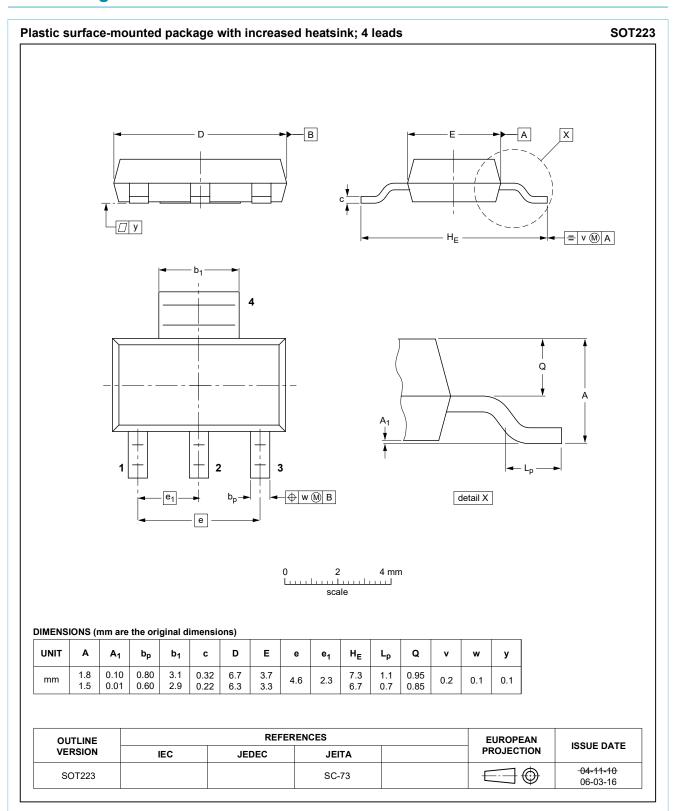


Fig. 15. Package outline SC-73 (SOT223)

### 11. Legal information

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Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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